

Surface-Mount Fast Switching Rectifiers

eSMP® Series



Cathode  Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1 A
V_{RRM}	200 V, 400 V, 600 V, 800 V, 1000 V
I_{FSM}	30 A
I_R	0.07 μ A
V_F at $I_F = 1$ A	0.88 V
T_J max.	150 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

FEATURES

- Glass passivated pellet chip junction
- Ideal for automated placement
- Meets MSL level 1, per J-STD-020; LF maximum peak of 260 °C
- Wave and reflow solderable
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	RS1FD	RS1FG	RS1FJ	RS1FK	RS1FM	UNIT
Device marking code		RSD	RSG	RSJ	RSK	RSM	
Max. repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Max. DC forward current (see fig. 1)	$I_F^{(1)}$	1					A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	30					A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150					°C

Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area



ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.0 A	T _J = 25 °C	V _F ⁽¹⁾	1.0	1.25	V
		T _J = 125 °C		0.88	1.15	
	I _F = 2.0 A	T _J = 25 °C		1.1	-	
		T _J = 125 °C		0.99	-	
Reverse current	Rated V _R	T _J = 25 °C	I _R ⁽²⁾	0.07	5.0	μA
		T _J = 125 °C		10.8	200	
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	-	500	ns
Typical junction capacitance	4.0 V, 1 MHz		C _J	5.0	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
 (2) Pulse test: pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)							
PARAMETER	SYMBOL	RS1FD	RS1FG	RS1FJ	RS1FK	RS1FM	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾⁽²⁾	130					°C/W
	R _{θJM} ⁽¹⁾	20					

Notes

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient; $R_{\theta JM}$ - junction-to-mount
 (2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
RS1FM-M3/H	0.0143	H	3000	7" diameter plastic tape and reel
RS1FM-M3/I	0.0143	I	10 000	13" diameter plastic tape and reel



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

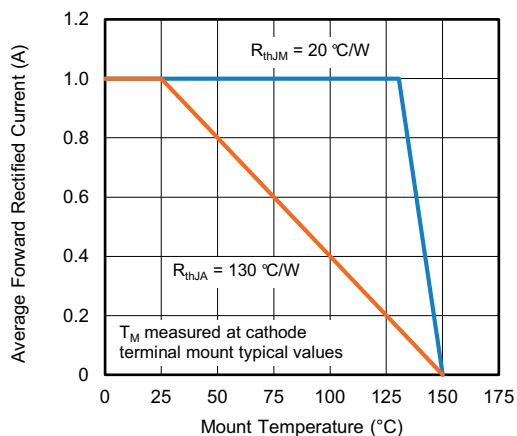


Fig. 1 - Max. Forward Current Derating Curve

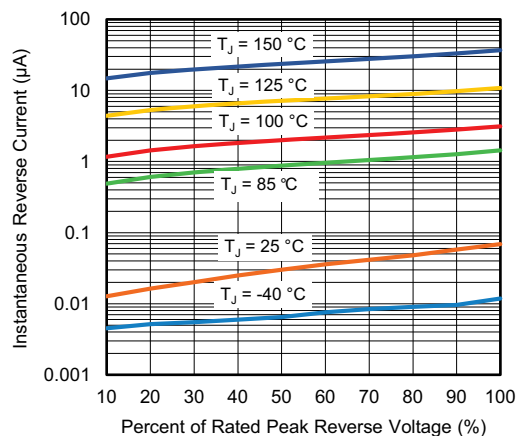


Fig. 4 - Typical Reverse Characteristics

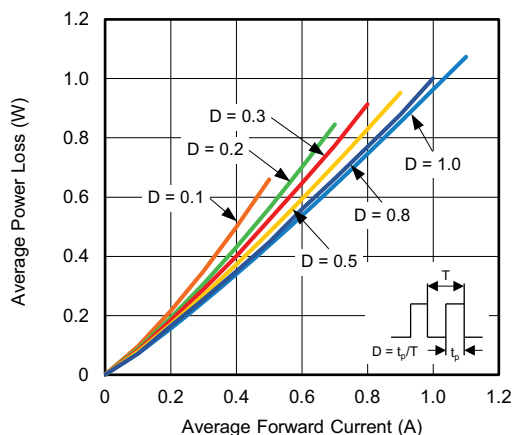


Fig. 2 - Forward Power Loss Characteristics

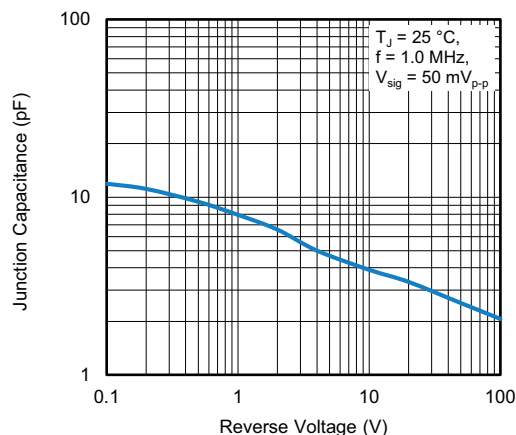


Fig. 5 - Typical Junction Capacitance

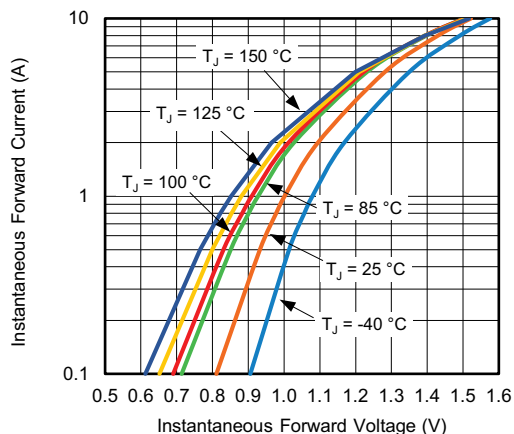


Fig. 3 - Typical Instantaneous Forward Characteristics

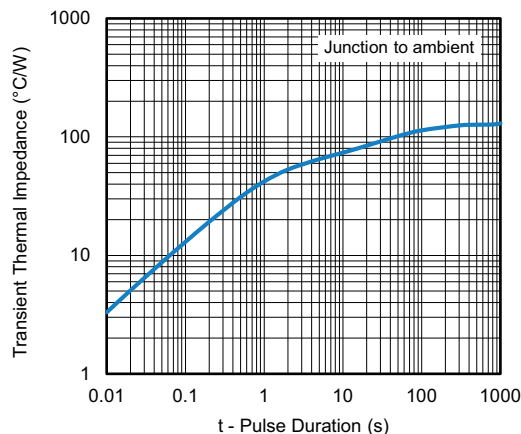
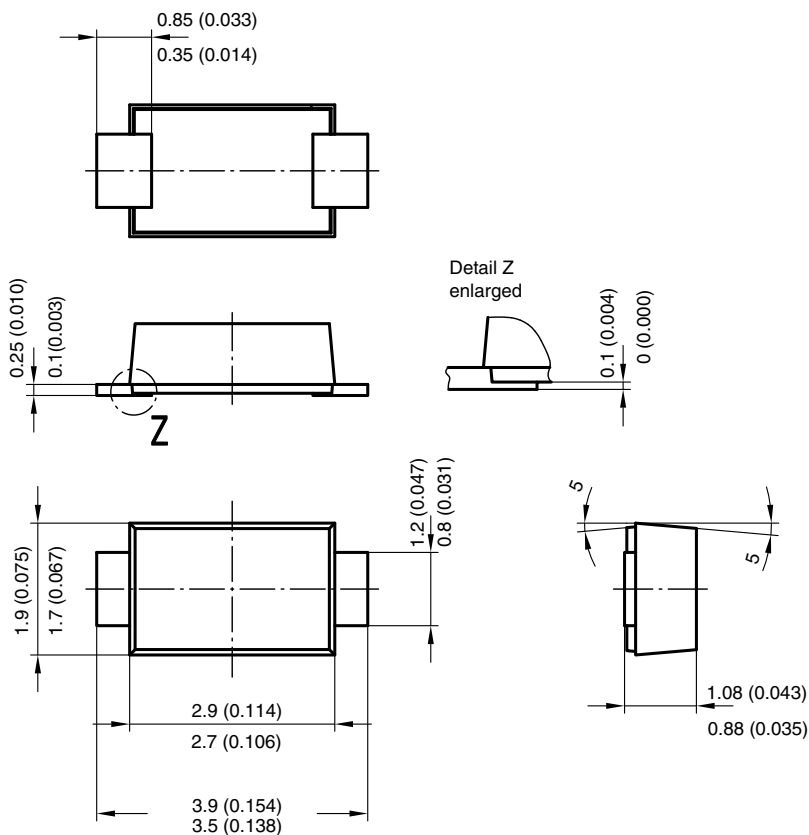


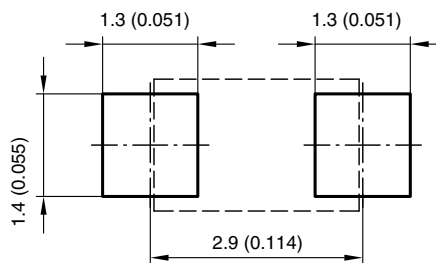
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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17247



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